



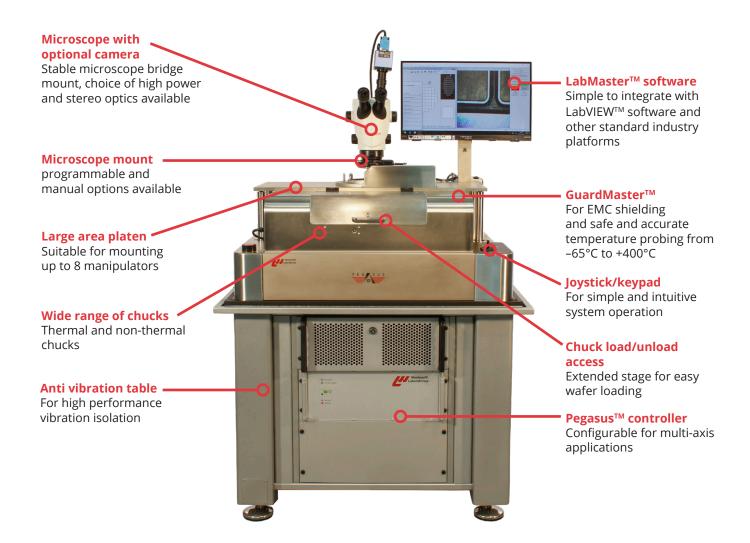
### **ANALYTICAL PROBERS**

# S200FA S300FA SEMI-AUTOMATIC





## KEY FEATURES



## DESIGNED FOR A WIDE RANGE OF APPLICATIONS

- Failure analysis
- Design verification
- Parametric testing
- Ideal for MEMS, HV/HC, RF and mmWave testing



## THE DESIGN

#### HIGH PRECISION

All Wentworth probers feature a robust chassis for mounting the prober stage.

The X-Y stage uses high precision motors with microstepping for greater accuracy. Ultra-high precision ball-screws reduce back lash and improve accuracy and repeatability.

The **Z stage** uses ultra-high precision multi-point lift ball-screws for superior linear rigidity. Additional multi-point linear bearings ensure increased torsional stiffness.

All stages are controlled by the **Pegasus™ Controller** consisting of the drive electronics, joystick, keypad and optional Windows user interface.

Interfacing is made easy with TTL, GPIB (IEEE488.2), RS232 and ethernet ports located on the back panel.

STAGE SPECIFICATION	
Repeatability	5 μm
Accuracy	+/- 5 μm

The Microscope Bridge is designed for strength and with standard PMM (Programmable Microscope Mount) as well as multiple Z axes PMM, which allows test equipment such as thermal cameras, spectrometers, integrating spheres, laser cutters and light sources to be independently controlled via the prober joystick functions. This feature allows the optics to be repositioned to enable direct device access from the top side.

The Pegasus™ S200FA and S300FA probers are designed with the operator in mind. Ergonomic controls make this one of the easiest prober platforms on the market today. Quick start up and simple menus allow users to be probing in minutes, whilst intuitive controls ensure that minimal operator training is required. The FA Series probers can be used in 'local' or 'remote' mode. This flexibility allows the prober to be easily integrated with industry standard testers and data acquisition software, such as LabVIEW™.

Using either the stand alone joystick (with menu driven controls) or our windows based graphical interface LabMaster<sup>TM</sup>, this platform is an ideal choice for both universities and commercial users.

#### **CONFIGURABLE DESIGN**

The Pegasus<sup>™</sup> S200FA and S300FA can be configured for a variety of applications at affordable cost. With over 50 years of experience serving the electronics industry, we can support even the most challenging application to be managed within standard lead times and budgets.

#### **ROBUST MECHANICS**

Using highest quality materials in its construction, the FA Series probers provide an extremely stable platform for sub-micron probing and precision applications such as laser cutting.

Lightweight chucks and drive mechanics allow extremely fast probing with no loss of accuracy.



Pegasus™ S300FA semi-automatic probe station

**EASE OF USE** 

## ANALYTICAL FLEXIBILITY



Pegasus™ S200FA with GuardMaster™ for low signal and low temperature probing

#### **FAILURE ANALYSIS**

Failure analysis applications require mechanical versatility and adaptability to make multiple measurements. The Pegasus™ S200FA and S300FA have been designed with these aspects in mind. Our full range of failure analysis tools and options such as manipulator probe heads/ needles, laser-ready optics and control/monitoring analysis software offer a wide choice of upgrade paths to ensure your system can grow with your testing requirements.

#### THERMAL CHARACTERIZATION

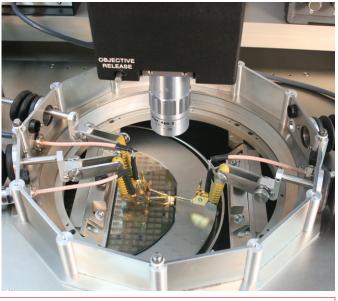
Our high performance thermal chuck solutions for device testing cover temperatures from -60°C to +400°C. To reduce thermal effects and keep the probing environment controlled, our propriety GuardMaster™ heating and cooling management system utilizing CDA or nitrogen.

OPTIONS	
Temperature	Control
- 30°C to +400°C	Active air cooled chuck system
- 60°C to +300°C	Air cooled high end system combining very low and high temperatures within one chuck system
-60°C to +300°C	Liquid cooled for high power applications

Analytical flexibility is at the core of our products, as well as mechanical stability and accuracy. Different measurements require different test methods and cabling solutions. Therefore, our bespoke and standard tester solution packages are configured in an easy-to-use 'plug and play' set-up. Our LabMaster™ software has the ability to communicate with both the tester and the prober's associated accessories, offering real-time data analysis and data acquisition.

#### **DYNAMIC TESTING**

The Pegasus<sup>™</sup> FA series probers include advanced utilities which allow the experienced user to design sophisticated test routines. These test routines may then be re-used for automated testing, saving time and increasing productivity. A 'quiet mode' option removes power to all motors to reduce the noise floor.



Pegasus™ S200FA with lower GuardMaster™ chamber

## USER INTERFACE

#### LABMASTER™ CONTROL & MONITORING SOFTWARE

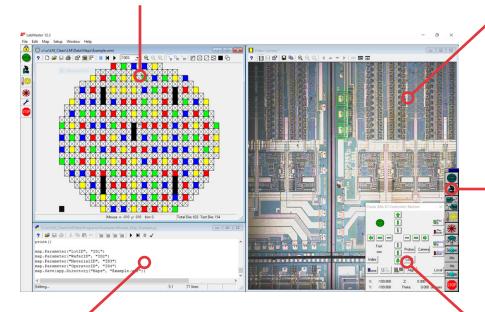
LabMaster™ is a simple-to-use Windows based graphical interface which allows real-time, fully integrated monitoring and control. It integrates with LabVIEW™ and other industry standard platforms and controls the Pegasus™ prober via either an RS232 interface or a GPIB (IEEE488.2) interface using the National Instruments PCI-GPIB board.

#### **Wafer Map Window**

Powerful failure analysis tool used for device navigation and positioning, as well as for displaying and storing die-binning information. Using the Wafer Map window, enables the user to quickly position the chuck to any die on the wafer. Wafer maps can be stored locally at the prober and saved as a simple text file (SINF - comma separated value), for easy transfer import/export.

#### **Video Window**

Displays real-time video from the camera attached to the microscope by using an overlay video board. Any image shown in the LabMaster™ video window can be saved to disk in a variety of image formats, or copied to the Windows clipboard for pasting into other Windows applications. ✓



#### **Device Toolbar**

Contains the device buttons for controlling external devices such as the probe platform, programmable microscope mount (PMM), submicron automated manipulators (SAMs), thermal chucks, lasers and microscope auto zoom functions. The hardware setup dialogue box is used to add or remove devices from the toolbar. It can also be used to modify a device's hardware setup parameters.

#### **Text Editor Window**

Can be used to create, edit and run REXX and Python programs. Multiple edit windows can be open at any one time, allowing you to cut and paste text from one window to another. The edit window toolbar contains buttons for frequently used functions such as Open, Save, Run, Stop and Syntax Check.

#### Pegasus™ Motion Control Window

Can be used to control the motion of the prober's chuck, SAMs and the PMM. All can be controlled individually, and, in addition, the SAM and PMM can be moved together for in-die probing. The arrow buttons are used to index the prober the distance specified by the index step values entered using the probers setup dialogue box. Slow, medium and fast velocity function buttons allow easy navigation between different areas on the wafer.

#### **OFFLINE TOOLS**

The Wentworth Labs **Wafer Map Editor** is an offline editor/viewer for LabMaster<sup>™</sup> compatible wafer map files and wafer map file templates. It allows for wafer map templates to be created and modified prior to being used for wafer testing. Wafer results files can also be viewed in this application and used to generate further template files.

## LEADING EDGE APPLICATIONS

#### DC PARAMETRIC

Utilizing Wentworth replaceable Pegasus<sup>™</sup> probes or DC cantilever probe cards, the Pegasus<sup>™</sup> S200FA and S300FA probers are an ideal platform for parametric testing. Tunable stage speeds and product enhancing accessories allow for fast probing and increased through-put, whilst chuck solutions enable probing of full wafers, shards, single chips and packaged devices.

## allow for fast probing and increased through-put, whilst chuck solutions enable probing of full wafers, shards, single chips and packaged devices. SPECIFICATION Frequency DC > 100Mhz Breakdown Voltage 500V

Analytical DC Test

#### **HIGH POWER**

Leakage (depending on configuration)

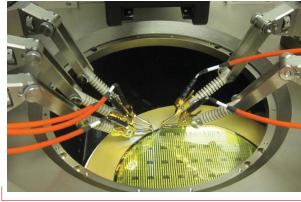
A high power configuration addresses today's power semiconductor test challenges with low contact resistance measurements requiring accuracy at high voltages. Kelvin chucks and backside probing solutions allow contact resistance measurements in the milliohm range.

down to +/-10fA -65°C > +200°C

down to +/-20fA +200°C > +400°C

High current probes and probe cards (up to 100A) handle and distribute excessive current loads. Dedicated HV and HC probes reduce probe and device destruction at high voltages/ currents by preventing arcing at the tip.





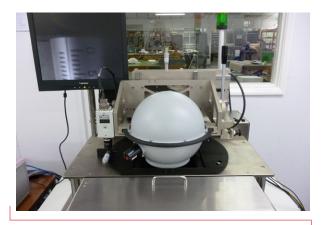
High Power Test

#### OPTO ELECTRONICS

Our FA Series probers can be specifically designed for production and analytical probing of semiconductor light-LEDs, laser diodes and optical MEMS devices.

Chuck solutions allow handling of full wafers, shards, single chips and packaged parts. The set-up can accommodate spectrometer probes, fibre optics, integrating spheres, glass chucks, thermal imaging cameras and more.

SPECIFICATION		
Speed	Up to 20 dies/sec (70,000 / hr)	
Reverse emission	Glass chuck, DSP, back side	
Controllable contact force	Pegasus <sup>™</sup> probe (open loop to prober Z -Stage)	



Opto Electronics Test

## OPTIONS & ACCESSORIES

MICROSCOPE MOUNTS						
Туре	Travel X/Y	Travel Z	Resolution	Drive	Recommended Microscope	Application
Manual stereozoom (MMM)	50x50mm	50mm*	0.9 μm	High precision lead screws	Binocular or trinocular stereozoom microscope	General probing, pad sizes down to 50µm x 50µm
Manual high powered (MMM)	50x50mm	75mm quicklift + 50mm**	0.9 μm	High precision lead screws	Compound high mag objective microscope	Small geometry pad or line probing down to 1-2µm
Programmable (PMM)	50x50mm	100mm + 50mm**	0.1 µm	Stepper motors	Compound high mag objective microscope	Small geometry pad or line probing down to 1-2µm

<sup>\*</sup>achieved through standard stereozoom focus arm

<sup>\*\*</sup> when using heavy duty focus block

MICROSCOPES	;	
Microscope Type	Models Available	Application
Stereo zoom	Wentworth, Leica	Pad probing and internal features down to 5 $\mu m$
High magnification	Mitutoyo FS-70 Series, A-Zoom	Offers the most flexibility and options for features down to 0.5 $\mu m$
Without eyepieces	A-Zoom, Mono-Zoom	Use with CCD or video systems.

MANIPULATORS		
	Туре	TPI / Resolution / Travel
	PVX400 (Vacuum or Magnetic)	50 TPI / 1.2 $\mu$ m/° / X = +/- 5 mm, Y = +/- 5 mm, Z = >5 mm
	PVX500-100 (Vacuum or Magnetic)	100 TPI / 0.7 $\mu$ m/° / X = +/- 5 mm, Y = +/ -5 mm, Z = >5 mm
	PVX500-200 (Vacuum or Magnetic)	200 TPI / 0.4 $\mu$ m/° / X = +/-5 mm, Y = +/- 5 mm, Z = >5 mm
	SAM (Programmable)	$0.1 \ \mu m/^{\circ} / X = 30 \ mm, \ Y = 30 \ mm, \ Z = 30 \ mm$

COMMUNICATION INTERFACES				
Туре	Vendors			
TTL	(2) 15-way D plugs each providing (4) TTL signal outputs & (8) TTL inputs			
RS232	Serial 9-pin D connector			
GPIB (IEEE488.2)	8-bit parallel multi-master interface bus			
Ethernet	48-bit MAC address			

ACCESSORIES	
Probes: Triaxial, coaxial, low impedance, Kelvin, high power	Thermal chucks: Heating, cooling, fast ramp/cool times
Probe tips: Tungsten, Tungsten-Carbide, Be Cu, gold plated	Probe cards: Ceramic blade, epoxy cantilever, custom solutions
<b>GuardMaster™:</b> Combined light-tight and EMC shielded enclosure for low level measurements and frost-free low temperature probing	<b>Automatic 2-point align:</b> Provides system automation and fast device set-up routine
Manual Manipulator (PVX): Magnetic and vacuum options	<b>Pattern recognition:</b> Automatic die detection and probe to pad alignment
<b>Programmable Computer Controlled Manipulators:</b> For submicron and in die probing	<b>Packaged device holders:</b> Held down by vacuum on the chuck's surface
<b>Pin Hole chucks:</b> Designed for thin wafers <150 μm thick. Definable vacuum patterns and single device holders	<b>Probe card holders:</b> 4.5" and 6" low profile probe card holder (PCH)
Laser cutter: Laser ablation, depassivating, cutting and trimming	<b>Chuck solutions:</b> Standard, gold plated, waffle tray, single devices, interchangeable, glass, ceramic, double sided, Kelvin
Dark boxes: External open dark boxes with cable patch panels	Supplies: Vacuum pumps and air compressors
<b>Camera and monitors:</b> Facilitates contacting bond pads or taking images	<b>LabMaster™</b> Control and monitoring graphical user interface
<b>Anti vibration tables:</b> Robust anti vibration design for dampening external vibrations	Quiet Mode: Removes power to all motors to reduce the noise floor.
Interface panels: Coax BNC, triax BNC, SHV, HV triax, D-SUB, SSMA, SMB, banana	<b>Triaxial chucks:</b> For reduced leakage and capacitance measurements

## **SPECIFICATION**

#### PEGASUS™ S200/S300FA SEMI-AUTOMATIC PROBE STATION

	Pegasus S200FA	Pegasus S300FA
Chuck Stage		
X-Y Stage		
Precision ball-screv	vs & stepper motors	
Travel	210 mm x 314 mm	310mm x 400mm
Resolution	0.312 μm	0.312 μm
Repeatability	± 4.0 μm	± 4.0 µm
Accuracy	± 5.0 μm	± 5.0 μm
Planarity	8 µm	8 µm
Maximum speed	100 mm/sec	100 mm/sec
Z Stage		
Precision ball-screw	vs & stepper motors	
Travel	11mm	11mm
Resolution	0.156 μm	0.156 μm
Repeatability	± 1.0 μm	± 1.0 μm
Theta Stage		
Travel	± 8.0°	± 8.0°
Resolution	0.0001°	0.0001°
Programmable Mid	croscope Mount	
Stepper Motors		
Travel	50mm x 50mm x 100mm	50mm x 50mm x 100mm
Resolution	0.15 µm	0.15 μm
Repeatability	± 1.0 μm	± 1.0 μm
Accuracy	± 2.5 μm	± 2.5 μm

Pegasus Si Probe Platform  Drive type Stepper r Z Travel  Material Nickel plate  Graphical User Interface  Communication Interfaces	notors 18mm d steel	Stepper motors 18mm Nickel plated steel		
Drive type Stepper r Z Travel  Material Nickel plate  Graphical User Interface	18mm d steel	18mm Nickel plated steel		
Z Travel  Material Nickel plate  Graphical User Interface	18mm d steel	18mm Nickel plated steel		
Material Nickel plate Graphical User Interface	d steel	Nickel plated steel		
Graphical User Interface		·		
	Wind	dows 7, 8.1 and 10		
Communication Interfaces	Wind	dows 7, 8.1 and 10		
Communication Interfaces				
communication interfaces				
PC TTL, RS232,	GPIB (IE	EE488.2), ETHERNET		
Utilities				
Power 100-24	10 VAC !	50/60 Hz select 600VA		
Vacuum	(	0.5 cfm @20" Hg (min)		
Compressed air		4 bar min		
Dimensions (WxDxH)				
Prober (excludes 840 x 842 x 6 optics)	840 x 842 x 610mm 880 x 875 x 610m			
Controller 45	450 x 480 x 180 mm 17.5 x 19.5 x 7"			
Shielding				
Light		> 120 db		
EMI > 20 db 0.05	5 - 0.5 G	ihz, 30 db 0.5 - 3Ghz		
Weight				
Prober	155kg	190 kg		
Controller	13 kg	13 kg		

#### **ABOUT WENTWORTH LABORATORIES**

With over 50 years experience in wafer probing technology, our solutions are the number one choice for many leading-edge wafer test applications across the globe.

With the support of a world-wide network of representatives, we enable our customers to fulfil even the most challenging wafer probing goals, maximizing their productivity and reducing costs.

We look forward to discussing your wafer probing requirements.

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